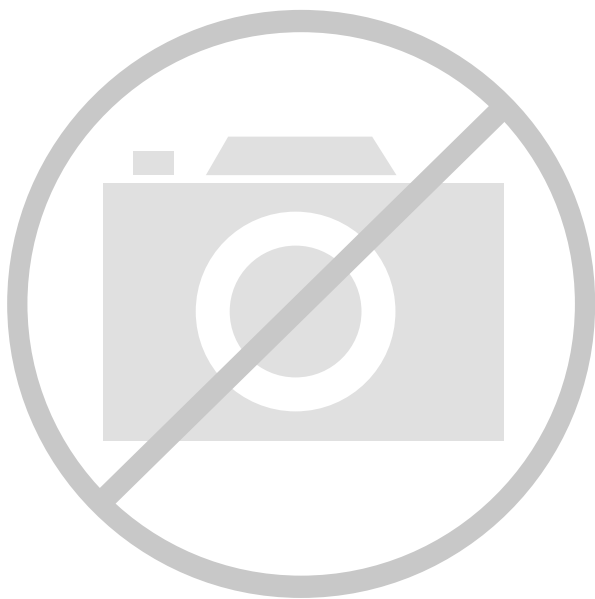




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Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Active
Core Processor	AVR
Core Size	8/16-Bit
Speed	32MHz
Connectivity	I ² C, IrDA, SPI, UART/USART, USB
Peripherals	Brown-out Detect/Reset, DMA, POR, PWM, WDT
Number of I/O	34
Program Memory Size	128KB (64K x 16)
Program Memory Type	FLASH
EEPROM Size	2K x 8
RAM Size	8K x 8
Voltage - Supply (Vcc/Vdd)	1.6V ~ 3.6V
Data Converters	A/D 12x12b; D/A 2x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	-
Package / Case	-
Supplier Device Package	-
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/atxmega128a4u-w

12.4.2 Brownout Detection

The on-chip brownout detection (BOD) circuit monitors the V_{CC} level during operation by comparing it to a fixed, programmable level that is selected by the BODLEVEL fuses. If disabled, BOD is forced on at the lowest level during chip erase and when the PDI is enabled.

12.4.3 External Reset

The external reset circuit is connected to the external $\overline{\text{RESET}}$ pin. The external reset will trigger when the $\overline{\text{RESET}}$ pin is driven below the $\overline{\text{RESET}}$ pin threshold voltage, V_{RST} , for longer than the minimum pulse period, t_{EXT} . The reset will be held as long as the pin is kept low. The $\overline{\text{RESET}}$ pin includes an internal pull-up resistor.

12.4.4 Watchdog Reset

The watchdog timer (WDT) is a system function for monitoring correct program operation. If the WDT is not reset from the software within a programmable timeout period, a watchdog reset will be given. The watchdog reset is active for one to two clock cycles of the 2MHz internal oscillator. For more details see [“WDT – Watchdog Timer” on page 28](#).

12.4.5 Software Reset

The software reset makes it possible to issue a system reset from software by writing to the software reset bit in the reset control register. The reset will be issued within two CPU clock cycles after writing the bit. It is not possible to execute any instruction from when a software reset is requested until it is issued.

12.4.6 Program and Debug Interface Reset

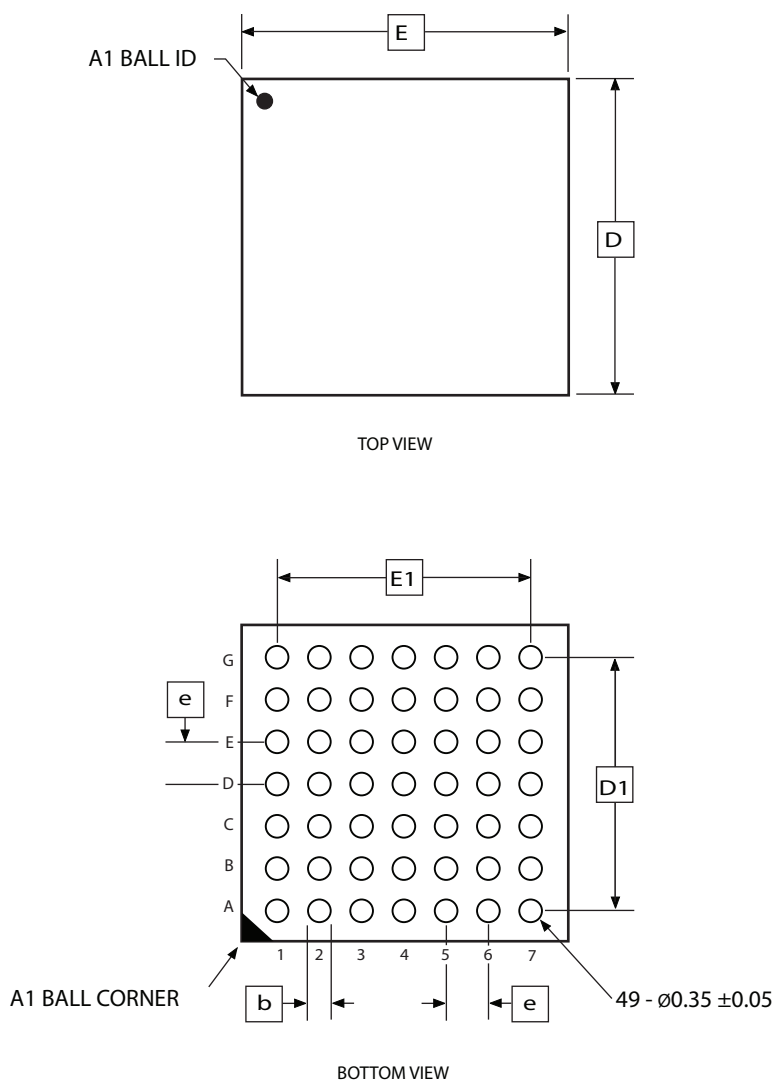
The program and debug interface reset contains a separate reset source that is used to reset the device during external programming and debugging. This reset source is accessible only from external debuggers and programmers.

Base address	Name	Description
0x0620	PORTB	Port B
0x0640	PORTC	Port C
0x0660	PORTD	Port D
0x0680	PORTE	Port E
0x07E0	PORTR	Port R
0x0800	TCC0	Timer/Counter 0 on port C
0x0840	TCC1	Timer/Counter 1 on port C
0x0880	AWEXC	Advanced Waveform Extension on port C
0x0890	HIRESC	High Resolution Extension on port C
0x08A0	USARTC0	USART 0 on port C
0x08B0	USARTC1	USART 1 on port C
0x08C0	SPIC	Serial Peripheral Interface on port C
0x08F8	IRCOM	Infrared Communication Module
0x0900	TCD0	Timer/Counter 0 on port D
0x0940	TCD1	Timer/Counter 1 on port D
0x0990	HIRESD	High Resolution Extension on port D
0x09A0	USARTD0	USART 0 on port D
0x09B0	USARTD1	USART 1 on port D
0x09C0	SPID	Serial Peripheral Interface on port D
0x0A00	TCE0	Timer/Counter 0 on port E
0x0A80	AWEXE	Advanced Waveform Extension on port E
0x0A90	HIRESE	High Resolution Extension on port E
0x0AA0	USARTE0	USART 0 on port E

34. Instruction Set Summary

Mnemonic s	Operand s	Description	Operation	Flags	#Clock s
Arithmetic and Logic Instructions					
ADD	Rd, Rr	Add without Carry	$Rd \leftarrow Rd + Rr$	Z,C,N,V,S,H	1
ADC	Rd, Rr	Add with Carry	$Rd \leftarrow Rd + Rr + C$	Z,C,N,V,S,H	1
ADIW	Rd, K	Add Immediate to Word	$Rd \leftarrow Rd + 1:Rd + K$	Z,C,N,V,S	2
SUB	Rd, Rr	Subtract without Carry	$Rd \leftarrow Rd - Rr$	Z,C,N,V,S,H	1
SUBI	Rd, K	Subtract Immediate	$Rd \leftarrow Rd - K$	Z,C,N,V,S,H	1
SBC	Rd, Rr	Subtract with Carry	$Rd \leftarrow Rd - Rr - C$	Z,C,N,V,S,H	1
SBCI	Rd, K	Subtract Immediate with Carry	$Rd \leftarrow Rd - K - C$	Z,C,N,V,S,H	1
SBIW	Rd, K	Subtract Immediate from Word	$Rd + 1:Rd \leftarrow Rd + 1:Rd - K$	Z,C,N,V,S	2
AND	Rd, Rr	Logical AND	$Rd \leftarrow Rd \bullet Rr$	Z,N,V,S	1
ANDI	Rd, K	Logical AND with Immediate	$Rd \leftarrow Rd \bullet K$	Z,N,V,S	1
OR	Rd, Rr	Logical OR	$Rd \leftarrow Rd \vee Rr$	Z,N,V,S	1
ORI	Rd, K	Logical OR with Immediate	$Rd \leftarrow Rd \vee K$	Z,N,V,S	1
EOR	Rd, Rr	Exclusive OR	$Rd \leftarrow Rd \oplus Rr$	Z,N,V,S	1
COM	Rd	One's Complement	$Rd \leftarrow \$FF - Rd$	Z,C,N,V,S	1
NEG	Rd	Two's Complement	$Rd \leftarrow \$00 - Rd$	Z,C,N,V,S,H	1
SBR	Rd,K	Set Bit(s) in Register	$Rd \leftarrow Rd \vee K$	Z,N,V,S	1
CBR	Rd,K	Clear Bit(s) in Register	$Rd \leftarrow Rd \bullet (\$FFh - K)$	Z,N,V,S	1
INC	Rd	Increment	$Rd \leftarrow Rd + 1$	Z,N,V,S	1
DEC	Rd	Decrement	$Rd \leftarrow Rd - 1$	Z,N,V,S	1
TST	Rd	Test for Zero or Minus	$Rd \leftarrow Rd \bullet Rd$	Z,N,V,S	1
CLR	Rd	Clear Register	$Rd \leftarrow Rd \oplus Rd$	Z,N,V,S	1
SER	Rd	Set Register	$Rd \leftarrow \$FF$	None	1
MUL	Rd,Rr	Multiply Unsigned	$R1:R0 \leftarrow Rd \times Rr (UU)$	Z,C	2
MULS	Rd,Rr	Multiply Signed	$R1:R0 \leftarrow Rd \times Rr (SS)$	Z,C	2
MULSU	Rd,Rr	Multiply Signed with Unsigned	$R1:R0 \leftarrow Rd \times Rr (SU)$	Z,C	2
FMUL	Rd,Rr	Fractional Multiply Unsigned	$R1:R0 \leftarrow Rd \times Rr << 1 (UU)$	Z,C	2
FMULS	Rd,Rr	Fractional Multiply Signed	$R1:R0 \leftarrow Rd \times Rr << 1 (SS)$	Z,C	2
FMULSU	Rd,Rr	Fractional Multiply Signed with Unsigned	$R1:R0 \leftarrow Rd \times Rr << 1 (SU)$	Z,C	2
DES	K	Data Encryption	if (H = 0) then R15:R0 $\leftarrow$ Encrypt(R15:R0, K) else if (H = 1) then R15:R0 $\leftarrow$ Decrypt(R15:R0, K)		1/2
Branch instructions					
RJMP	k	Relative Jump	$PC \leftarrow PC + k + 1$	None	2
IJMP		Indirect Jump to (Z)	$PC(15:0) \leftarrow Z,$ $PC(21:16) \leftarrow 0$	None	2
EIJMP		Extended Indirect Jump to (Z)	$PC(15:0) \leftarrow Z,$ $PC(21:16) \leftarrow EIND$	None	2
JMP	k	Jump	$PC \leftarrow k$	None	3

35.4 49C2



COMMON DIMENSIONS
(Unit of Measure = mm)

SYMBOL	MIN	NOM	MAX	NOTE
A	–	–	1.00	
A1	0.20	–	–	
A2	0.65	–	–	
D	4.90	5.00	5.10	
D1	3.90 BSC			
E 4.90	5.00	5.10		
E1	3.90 BSC			
b	0.30	0.35	0.40	
e	0.65 BSC			

3/14/08

 Package Drawing Contact: packagedrawings@atmel.com	TITLE 49C2, 49-ball (7 x 7 array), 0.65mm pitch, 5.0 x 5.0 x 1.0mm, very thin, fine-pitch ball grid array package (VFBGA)	GPC	DRAWING NO.	REV.
		CBD	49C2	A

Table 36-13. Clock and timing.

Symbol	Parameter	Condition		Min.	Typ.	Max.	Units
f_{DAC}	Conversion rate	$C_{load}=100pF$, maximum step size	Normal mode	0		1000	ksps
			Low power mode			500	

Table 36-14. Accuracy characteristics.

Symbol	Parameter	Condition		Min.	Typ.	Max.	Units
RES	Input resolution					12	Bits
INL ⁽¹⁾	Integral non-linearity	$V_{REF}=Ext\ 1.0V$	$V_{CC} = 1.6V$		± 2.0	± 3	lsb
			$V_{CC} = 3.6V$		± 1.5	± 2.5	
		$V_{REF}=AV_{CC}$	$V_{CC} = 1.6V$		± 2.0	± 4	
			$V_{CC} = 3.6V$		± 1.5	± 4	
		$V_{REF}=INT1V$	$V_{CC} = 1.6V$		± 5.0		
			$V_{CC} = 3.6V$		± 5.0		
DNL ⁽¹⁾	Differential non-linearity	$V_{REF}=Ext\ 1.0V$	$V_{CC} = 1.6V$		± 1.5	3.0	lsb
			$V_{CC} = 3.6V$		± 0.6	1.5	
		$V_{REF}=AV_{CC}$	$V_{CC} = 1.6V$		± 1.0	3.5	
			$V_{CC} = 3.6V$		± 0.6	1.5	
		$V_{REF}=INT1V$	$V_{CC} = 1.6V$		± 4.5		
			$V_{CC} = 3.6V$		± 4.5		
	Gain error	After calibration			<4.0		lsb
	Gain calibration step size				4.0		lsb
	Gain calibration drift	$V_{REF}=Ext\ 1.0V$			<0.2		mV/K
	Offset error	After calibration			<1.0		lsb
	Offset calibration step size				1.0		

Note: 1. Maximum numbers are based on characterisation and not tested in production, and valid for 5% to 95% output voltage range.

Symbol	Parameter	Condition		Min.	Typ.	Max.	Units
	Offset error, input referred	1x gain, normal mode			-2.0		mV
		8x gain, normal mode			-5.0		
		64x gain, normal mode			-4.0		
	Noise	1x gain, normal mode	$V_{CC} = 3.6V$ Ext. V_{REF}		0.5		mV rms
		8x gain, normal mode			1.5		
		64x gain, normal mode			11		

Note: 1. Maximum numbers are based on characterisation and not tested in production, and valid for 5% to 95% input voltage range.

36.2.7 DAC Characteristics

Table 36-44. Power supply, reference and output range.

Symbol	Parameter	Condition		Min.	Typ.	Max.	Units
AV_{CC}	Analog supply voltage			$V_{CC} - 0.3$		$V_{CC} + 0.3$	V
AV_{REF}	External reference voltage			1.0		$V_{CC} - 0.6$	V
$R_{channel}$	DC output impedance					50	Ω
	Linear output voltage range			0.15		$AV_{CC} - 0.15$	V
R_{AREF}	Reference input resistance				>10		M Ω
C_{AREF}	Reference input capacitance	Static load			7.0		pF
	Minimum Resistance load			1.0			k Ω
	Maximum capacitance load					100	pF
		1000 Ω serial resistance				1.0	nF
	Output sink/source	Operating within accuracy specification				$AV_{CC}/1000$	mA
		Safe operation				10	

Table 36-45. Clock and timing.

Symbol	Parameter	Condition		Min.	Typ.	Max.	Units
f_{DAC}	Conversion rate	$C_{load} = 100pF$, maximum step size	Normal mode	0		1000	ksps
			Low power mode			500	

Symbol	Parameter	Condition		Min.	Typ.	Max.	Units
	Offset error, input referred	1x gain, normal mode			-2		mV
		8x gain, normal mode			-5		
		64x gain, normal mode			-4		
	Noise	1x gain, normal mode	$V_{CC} = 3.6V$ Ext. V_{REF}		0.5		mV rms
		8x gain, normal mode			1.5		
		64x gain, normal mode			11		

Note: 1. Maximum numbers are based on characterisation and not tested in production, and valid for 5% to 95% input voltage range.

36.3.7 DAC Characteristics

Table 36-76. Power supply, reference and output range.

Symbol	Parameter	Condition		Min.	Typ.	Max.	Units
AV_{CC}	Analog supply voltage			$V_{CC} - 0.3$		$V_{CC} + 0.3$	V
AV_{REF}	External reference voltage			1.0		$V_{CC} - 0.6$	V
$R_{channel}$	DC output impedance					50	Ω
	Linear output voltage range			0.15		$AV_{CC} - 0.15$	V
R_{AREF}	Reference input resistance				>10		M Ω
C_{AREF}	Reference input capacitance	Static load			7		pF
	Minimum resistance load			1.0			k Ω
	Maximum capacitance load					100	pF
		1000 Ω serial resistance				1.0	nF
	Output sink/source	Operating within accuracy specification				$AV_{CC}/1000$	mA
		Safe operation				10	

Table 36-77. Clock and timing.

Symbol	Parameter	Condition		Min.	Typ.	Max.	Units
f_{DAC}	Conversion rate	$C_{load} = 100pF$, maximum step size	Normal mode	0		1000	ksps
			Low power mode			500	

Table 36-95. SPI timing characteristics and requirements.

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
t_{SCK}	SCK period	Master		(See Table 21-4 in XMEGA AU Manual)		ns
t_{SCKW}	SCK high/low width	Master		$0.5 \cdot SCK$		
t_{SCKR}	SCK rise time	Master		2.7		
t_{SCKF}	SCK fall time	Master		2.7		
t_{MIS}	MISO setup to SCK	Master		11		
t_{MIH}	MISO hold after SCK	Master		0		
t_{MOS}	MOSI setup SCK	Master		$0.5 \cdot SCK$		
t_{MOH}	MOSI hold after SCK	Master		1.0		
t_{SSCK}	Slave SCK Period	Slave	$4 \cdot t_{Clk_{PER}}$			
t_{SSCKW}	SCK high/low width	Slave	$2 \cdot t_{Clk_{PER}}$			
t_{SSCKR}	SCK rise time	Slave			1600	
t_{SSCKF}	SCK fall time	Slave			1600	
t_{SIS}	MOSI setup to SCK	Slave	3.0			
t_{SIH}	MOSI hold after SCK	Slave	t_{PER}			
t_{SSS}	$\overline{SS}$ setup to SCK	Slave	20			
t_{SSH}	$\overline{SS}$ hold after SCK	Slave	20			
t_{SOS}	MISO setup SCK	Slave		8.0		
t_{SOH}	MISO hold after SCK	Slave		13.0		
t_{SOSS}	MISO setup after $\overline{SS}$ low	Slave		11.0		
t_{SOSH}	MISO hold after $\overline{SS}$ high	Slave		8.0		

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
	Duty cycle	XOSCPWR=0	FRQRANGE=0	40		%
			FRQRANGE=1	42		
			FRQRANGE=2 or 3	45		
		XOSCPWR=1		48		
R _Q	Negative impedance ⁽¹⁾	XOSCPWR=0, FRQRANGE=0	0.4MHz resonator, CL=100pF	2.4k		Ω
			1MHz crystal, CL=20pF	8.7k		
			2MHz crystal, CL=20pF	2.1k		
		XOSCPWR=0, FRQRANGE=1, CL=20pF	2MHz crystal	4.2k		
			8MHz crystal	250		
			9MHz crystal	195		
		XOSCPWR=0, FRQRANGE=2, CL=20pF	8MHz crystal	360		
			9MHz crystal	285		
			12MHz crystal	155		
		XOSCPWR=0, FRQRANGE=3, CL=20pF	9MHz crystal	365		
			12MHz crystal	200		
			16MHz crystal	105		
		XOSCPWR=1, FRQRANGE=0, CL=20pF	9MHz crystal	435		
			12MHz crystal	235		
			16MHz crystal	125		
		XOSCPWR=1, FRQRANGE=1, CL=20pF	9MHz crystal	495		
			12MHz crystal	270		
			16MHz crystal	145		
		XOSCPWR=1, FRQRANGE=2, CL=20pF	12MHz crystal	305		
			16MHz crystal	160		
		XOSCPWR=1, FRQRANGE=3, CL=20pF	12MHz crystal	380		
			16MHz crystal	205		
	ESR	SF = Safety factor			min(R _Q)/SF	kΩ
C _{XTAL1}	Parasitic capacitance XTAL1 pin			5.45		pF
C _{XTAL2}	Parasitic capacitance XTAL2 pin			7.51		pF
C _{LOAD}	Parasitic capacitance load			3.16		pF

Note: 1. Numbers for negative impedance are not tested in production but guaranteed from design and characterization.

Figure 37-78. 32MHz internal oscillator CALA calibration step size.

$V_{CC} = 3.0V$.

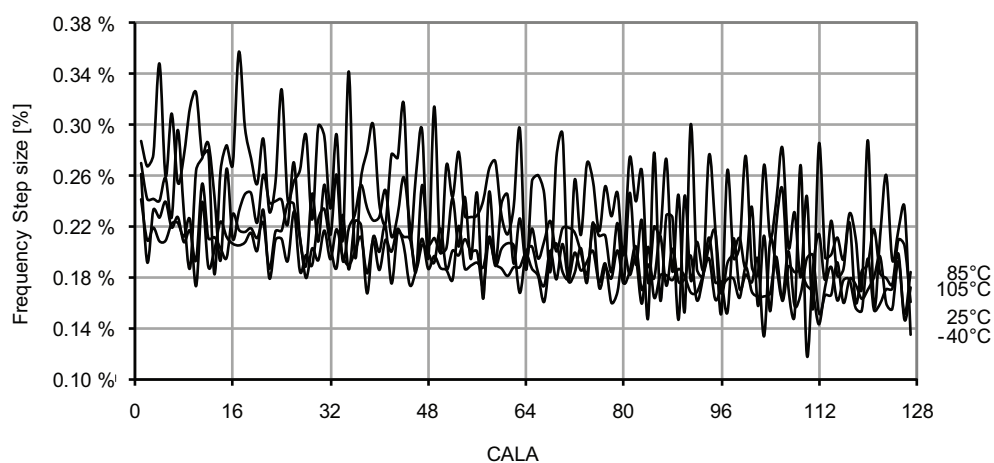


Figure 37-79. 32MHz internal oscillator frequency vs. CALB calibration value.

$V_{CC} = 3.0V$.

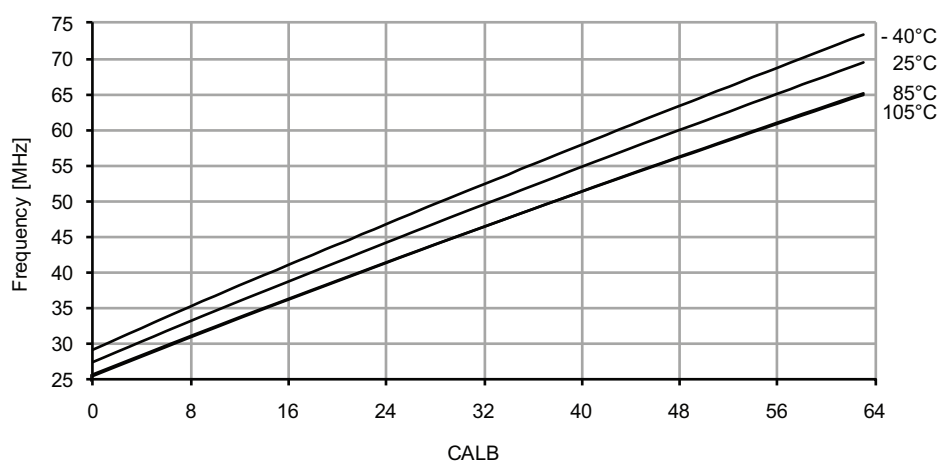
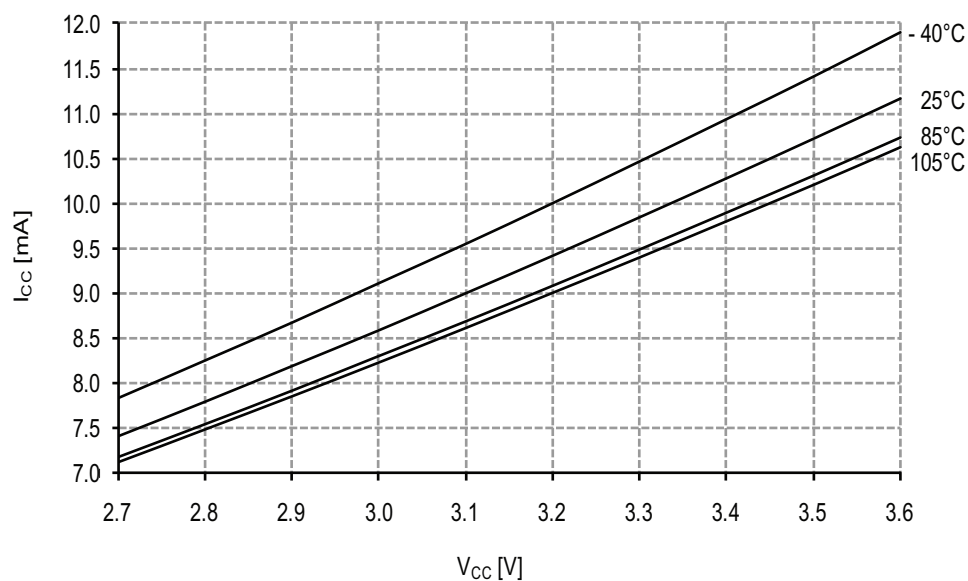


Figure 37-175. Active mode supply current vs. V_{CC} .

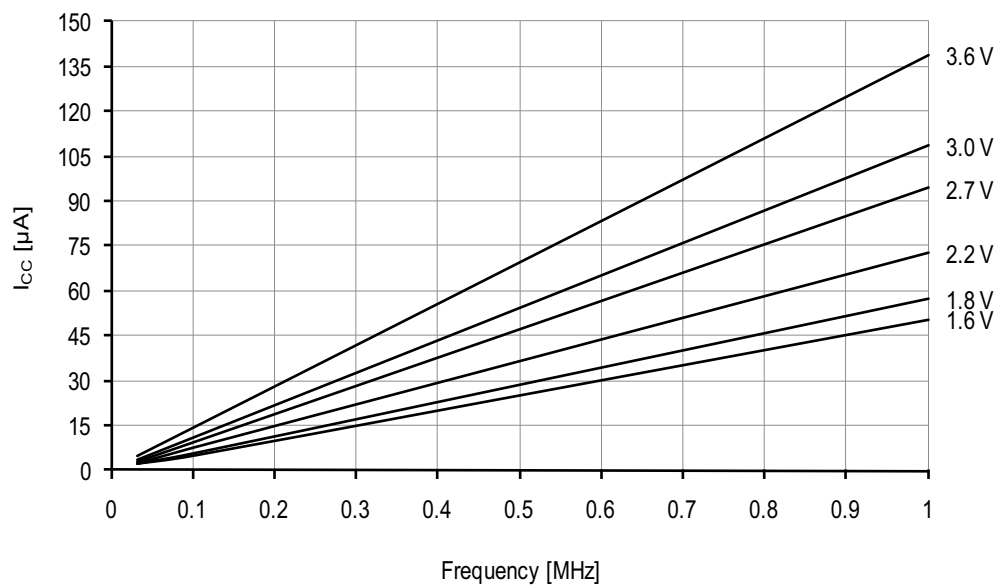
$f_{SYS} = 32\text{MHz}$ internal oscillator.



37.3.1.2 Idle mode supply current

Figure 37-176. Idle mode supply current vs. frequency.

$f_{SYS} = 0 - 1\text{MHz}$ external clock, $T = 25^{\circ}\text{C}$.



37.3.2 I/O Pin Characteristics

37.3.2.1 Pull-up

Figure 37-189. I/O pin pull-up resistor current vs. input voltage.

$V_{CC} = 1.8V$.

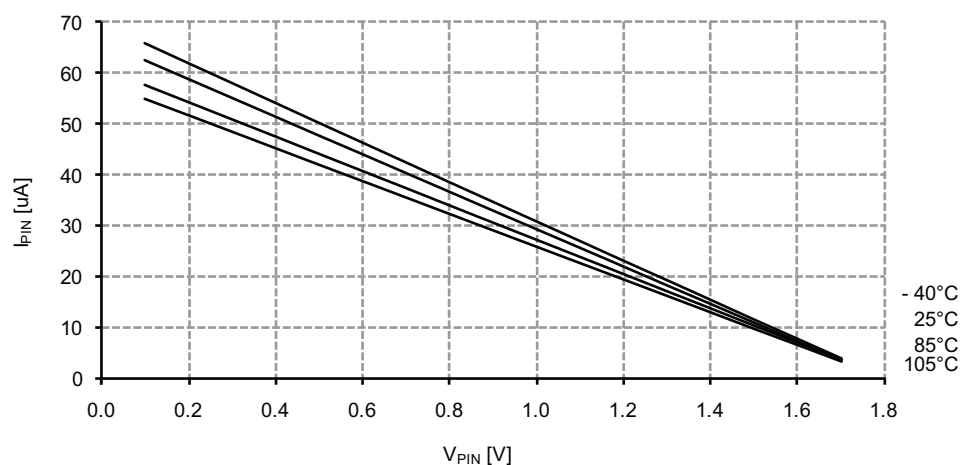


Figure 37-190. I/O pin pull-up resistor current vs. input voltage.

$V_{CC} = 3.0V$.

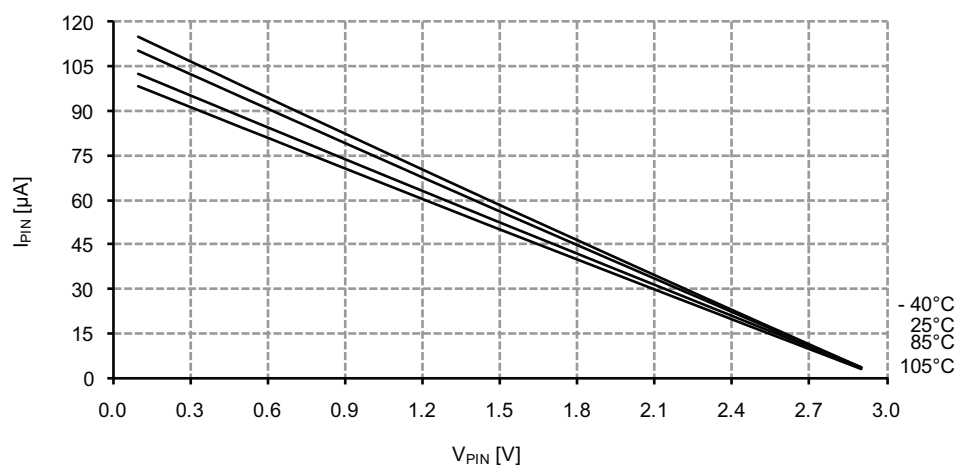


Figure 37-231. Reset pin pull-up resistor current vs. reset pin voltage.

$V_{CC} = 1.8V$.

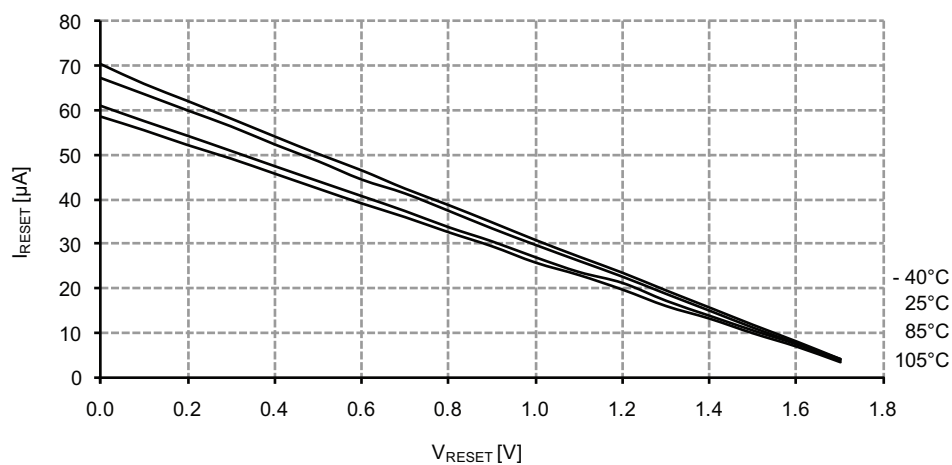


Figure 37-232. Reset pin pull-up resistor current vs. reset pin voltage.

$V_{CC} = 3.0V$.

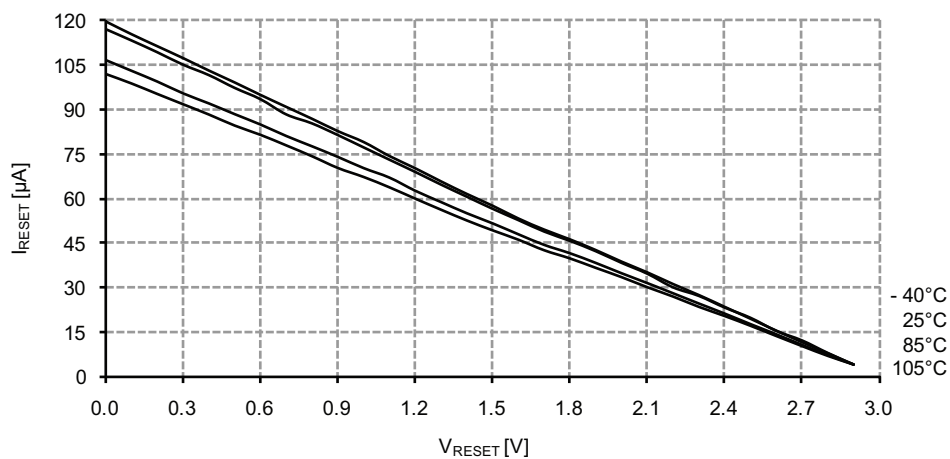
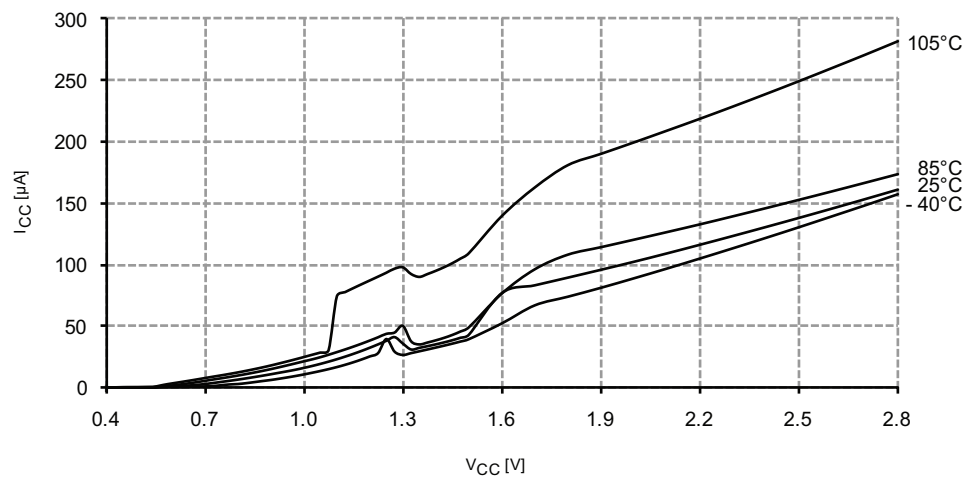


Figure 37-237. Power-on reset current consumption vs. V_{CC} .
BOD level = 3.0V, enabled in sampled mode.



37.3.10 Oscillator Characteristics

37.3.10.1 Ultra Low-Power internal oscillator

Figure 37-238. Ultra Low-Power internal oscillator frequency vs. temperature.

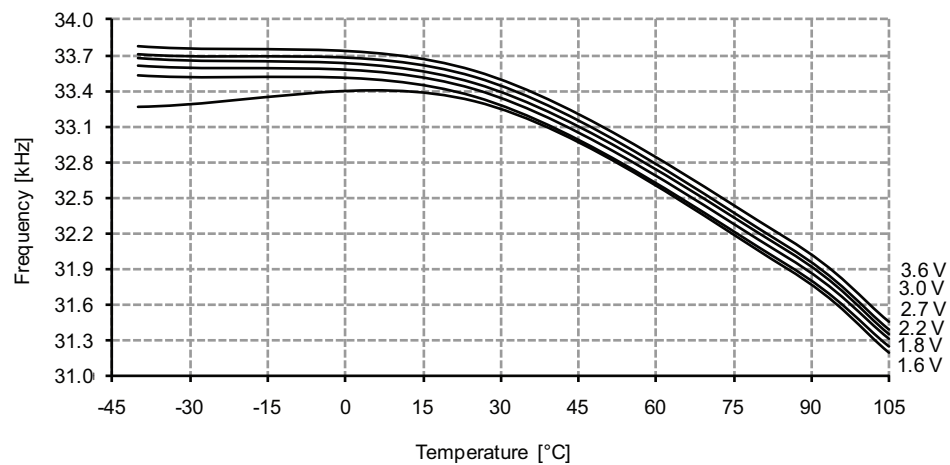


Figure 37-263. Idle mode supply current vs. V_{CC} .

$f_{SYS} = 1\text{MHz external clock}$

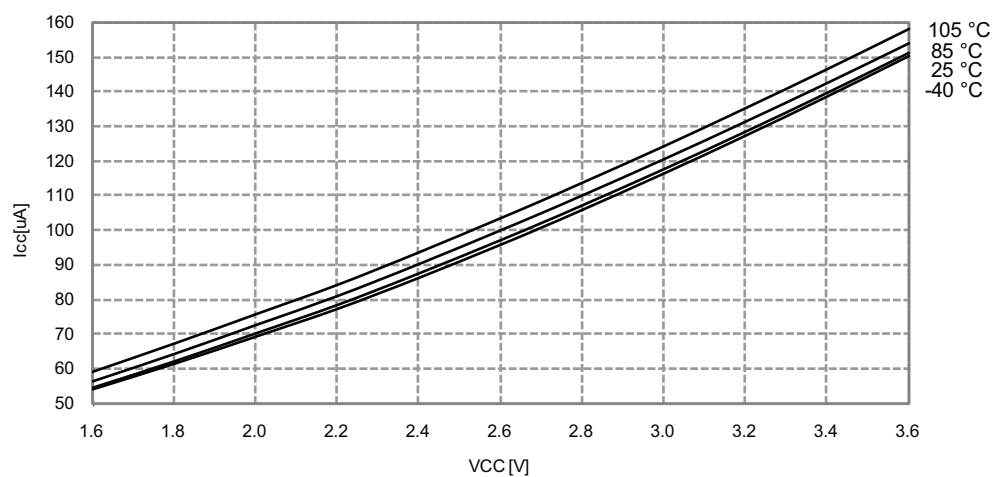


Figure 37-264. Idle mode supply current vs. V_{CC} .

$f_{SYS} = 2\text{MHz internal oscillator}$

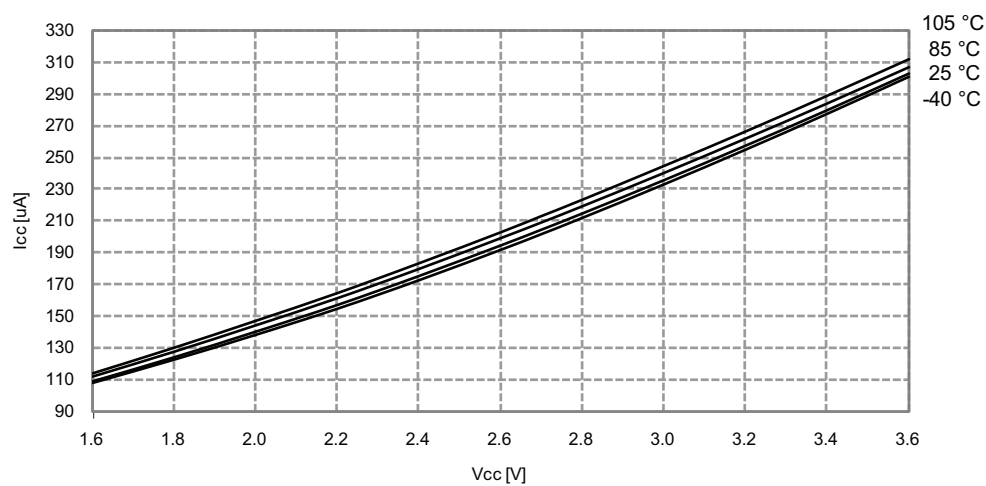


Figure 37-299. Noise vs. V_{REF}

$T = 25^{\circ}\text{C}$, $V_{CC} = 3.6\text{V}$, ADC sampling speed = 500kps

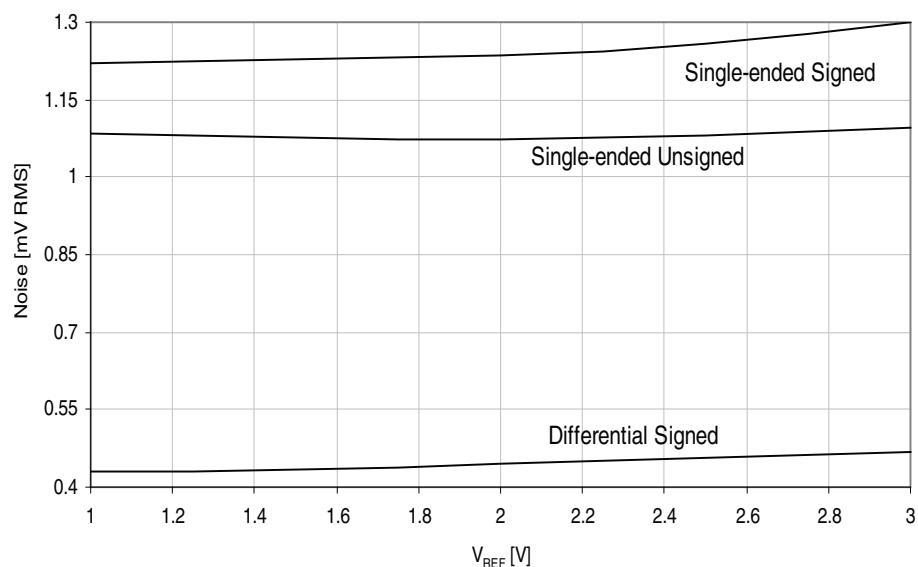
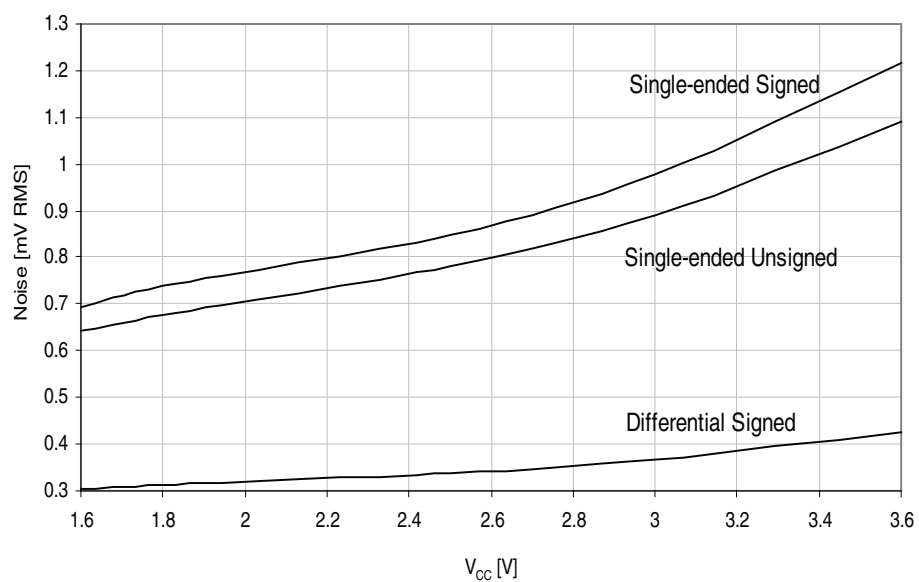


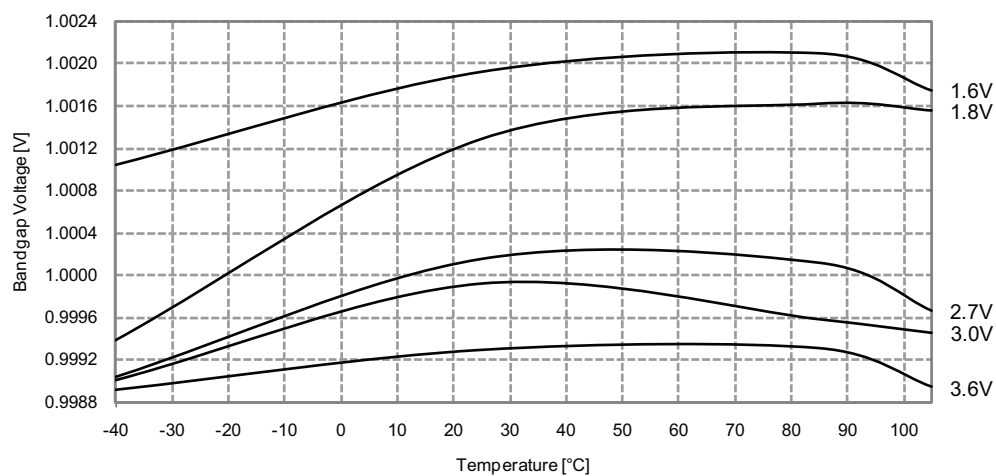
Figure 37-300. Noise vs. V_{CC}

$T = 25^{\circ}\text{C}$, $V_{REF} = \text{external } 1.0\text{V}$, ADC sampling speed = 500kps



37.4.6 Internal 1.0V reference Characteristics

Figure 37-311. ADC/DAC Internal 1.0V reference vs. temperature



37.4.7 BOD Characteristics

Figure 37-312. BOD thresholds vs. temperature.

BOD level = 1.6V

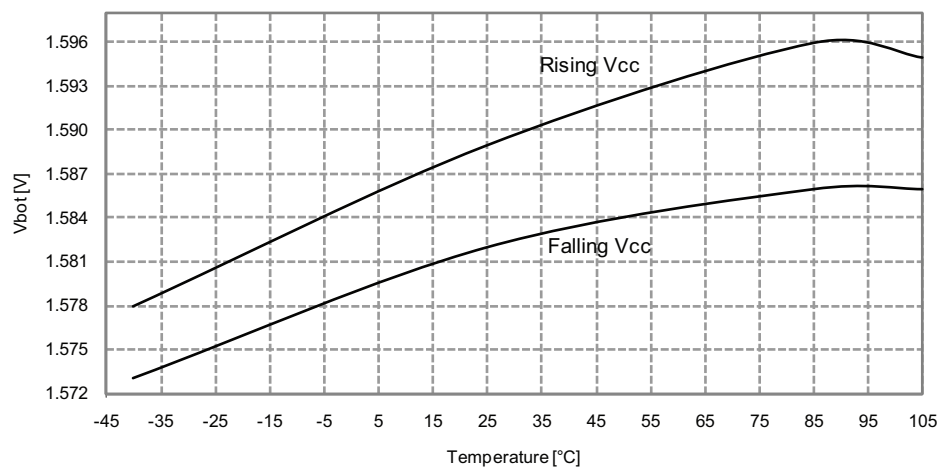


Figure 37-315. Reset pin pull-up resistor current vs. reset pin voltage

$V_{CC} = 1.8V$

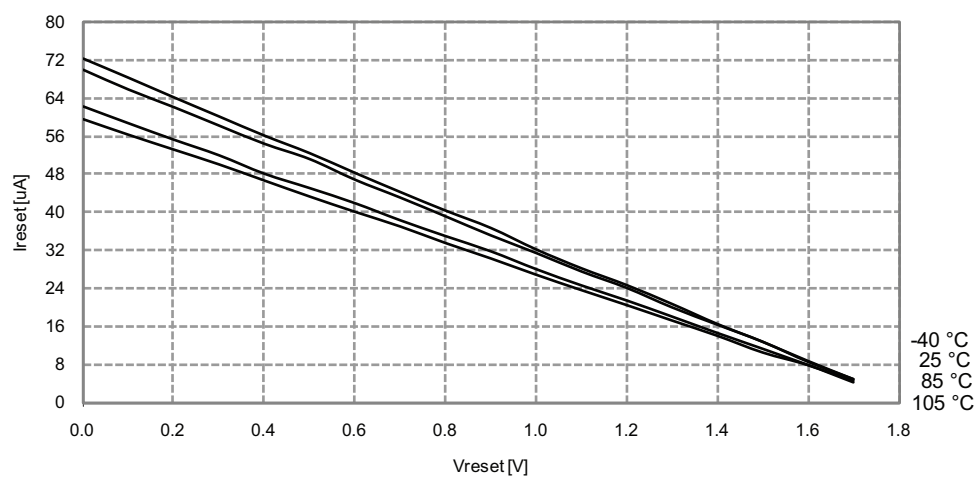
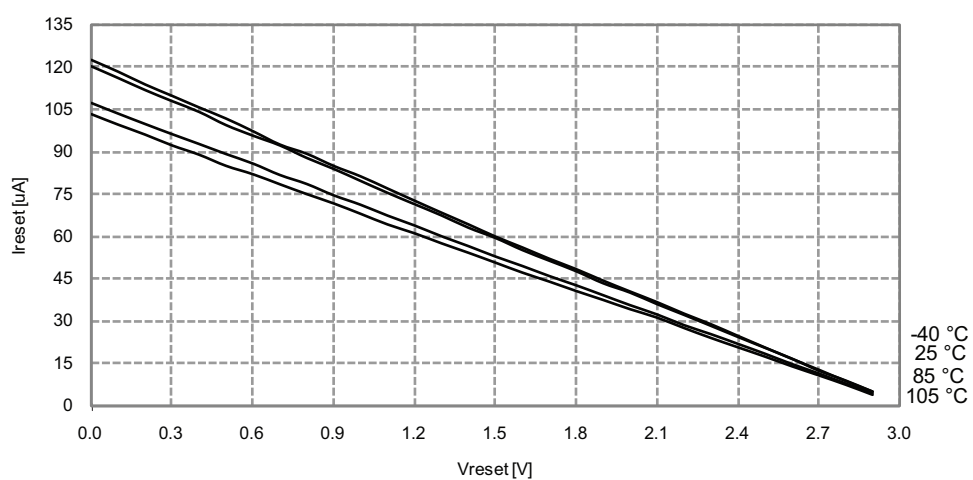


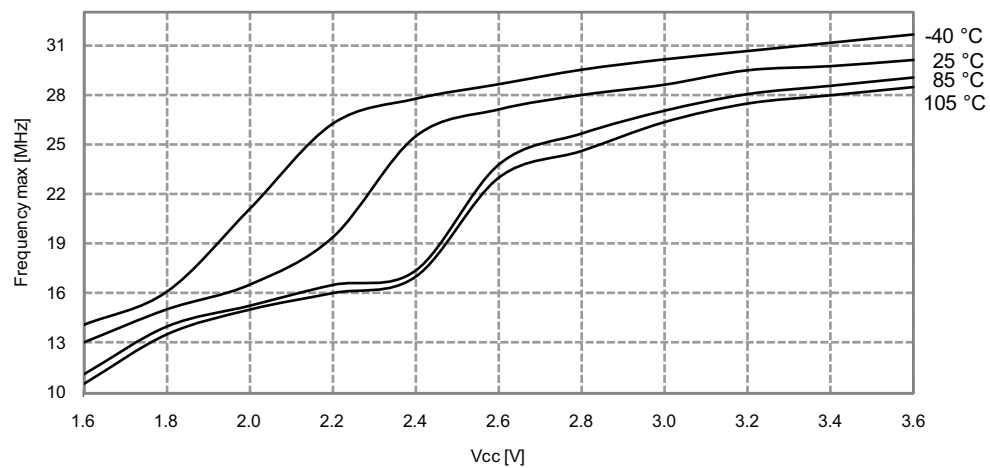
Figure 37-316. Reset pin pull-up resistor current vs. reset pin voltage

$V_{CC} = 3.0V$



37.4.12 PDI characteristics

Figure 37-335. Maximum PDI frequency vs. V_{CC}



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